

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

AXEL PREUSSE
MARKUS NOPPER
HOLGER SCHÜHRER

Patent No.: 7,169,664 B2

Issued: January 30, 2007

Serial No.: 10/747,722

Examiner: Edward Joseph Wojciechowicz

Confirmation No.: 5854

Group Art Unit: 2815

Filed: December 29, 2003

Att'y Docket: 2000.109700/DE0351

For: METHOD OF REDUCING WAFER
CONTAMINATION BY REMOVING
UNDER-METAL LAYERS AT THE
WAFER EDGE

Customer No.: 23720

REQUEST FOR CERTIFICATE OF CORRECTION

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

The patentee requests a certificate of correction for Patent and Trademark Office ("PTO") errors pursuant to 37 C.F.R. § 1.322. Because these errors were the PTO's, no fee should be required. If any fee is required, please charge Williams, Morgan & Amerson, P.C. Deposit Account No. 50-0786/2000.109700.

The following errors are listed on the attached form PTO-1050.

Col. 10, line 10 (claim 5, line 2), delete "comprises copper and".

Col. 10, line 39 (claim 11, line 8), after "barrier layer" insert -- comprising tantalum --.

Col. 10, line 40 (claim 11, line 9), after "layer" insert -- comprising copper --.

Col. 10, line 43 (claim 11, line 12), change "applyingi" to -- applying --.

Respectfully submitted,

WILLIAMS, MORGAN & AMERSON
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Date: February 6, 2007

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UNITED STATES PATENT AND TRADEMARK OFFICE **CERTIFICATE OF CORRECTION**

PATENT NO. : 7,169,664 B2
 DATED : January 30, 2007
 INVENTOR(S) : Axel Preusse, Markus Nopper and Holger Schührer

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below.

Col. 10, line 10 (claim 5, line 2), delete "comprises copper and".

Col. 10, line 39 (claim 11, line 8), after "barrier layer" insert -- comprising tantalum --.

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